# **MA4X713** (MA713)

# Silicon epitaxial planar type

#### For switching

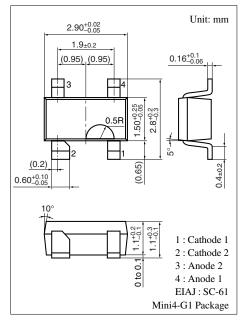
For wave detection

#### Features

- Two isolated elements are contained in one package, allowing high-density mounting
- Two MA3X704A (MA704A) is contained in one package (of a type in the same direction)
- Low forward voltage V<sub>F</sub>, optimum for low voltage rectification
- Optimum for high frequency rectification because of its short reverse recovery time (t<sub>rr</sub>)
- Mini type 4-pin package

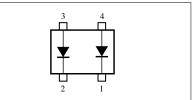
Parameter		Symbol	Rating	Unit				
Reverse voltage (DC)		V <sub>R</sub>	30	V				
Peak forward	Single	I <sub>FM</sub>	150	mA				
current	Double *		110					
Forward current (DC)	Single	I <sub>F</sub>	30	mA				
	Double *		20					
Junction temperature		Tj	125	°C				
Storage temperature		T <sub>stg</sub>	-55 to +125	°C				

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$



#### Marking Symbol: M1N

#### Internal Connection

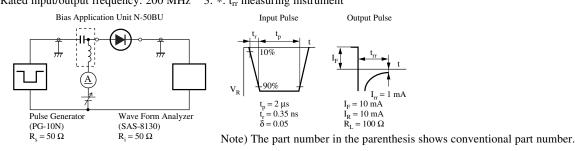


Note) \*: Value per chip

## Electrical Characteristics $T_a = 25^{\circ}C$

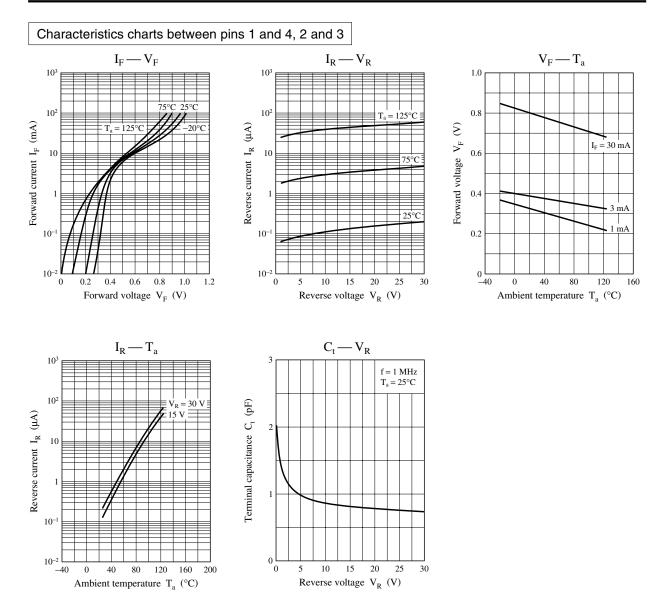
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse current (DC)	I <sub>R</sub>	$V_R = 30 V$			1	μΑ
Forward voltage (DC)	V <sub>F1</sub>	$I_F = 1 \text{ mA}$			0.4	V
	V <sub>F2</sub>	$I_F = 30 \text{ mA}$			1.0	
Terminal capacitance	Ct	$V_R = 1 V, f = 1 MHz$		1.5		pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = I_R = 10 \text{ mA}$		1.0		ns
		$I_{rr} = 1 \text{ mA}, R_L = 100 \Omega$				
Detection efficiency	η	$V_{in} = 3 V_{(peak)}$ , f = 30 MHz		65		%
		$R_L = 3.9 \text{ k}\Omega, C_L = 10 \text{ pF}$				

Note) 1. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.



2. Rated input/output frequency: 200 MHz 3. \*: t<sub>rr</sub> measuring instrument

Publication date: August 2001



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